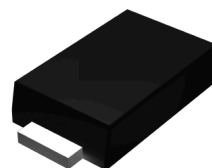


Features

- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s
- Low profile, typical thickness 1.0mm



Package: eSGB(SMAF)

Applications

For use in fast switching in RF module, lighting, cell phone, portable devices, power supply and other consumer applications.

Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	LSL22	LSL23	LSL24	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	30	40	V
Maximum RMS Voltage	V_{RMS}	14	21	28	V
Maximum DC Blocking Voltage	V_{DC}	20	30	40	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	2.0			A
Peak Forward Surge Current (8.3 ms single half sine-wave superimposed on rated load)	I_{FSM}	50			A
Operating Junction Temperature Range	T_J	- 55 to + 150			$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	- 55 to + 150			$^{\circ}\text{C}$

Electrical Characteristics ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Test Conditions	Symbol	Value	Unit
Instantaneous Forward Voltage	2 A	V_F	0.43	V
Reverse Current at Rated DC Blocking Voltage	$T_A=25^{\circ}\text{C}$	I_R	0.5	mA
	$T_A=125^{\circ}\text{C}$		30	
Junction Capacitance	4.0 V, 1 MHz	C_J	160	pF
Typical Thermal Resistance	Junction to Lead	$R_{\theta JL}$	30	$^{\circ}\text{C/W}$

Note1: Thermal resistance from junction to lead, mounted on PCB with 0.315×0.315 " (8.0×8.0mm) copper pads

Ratings and Characteristics Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

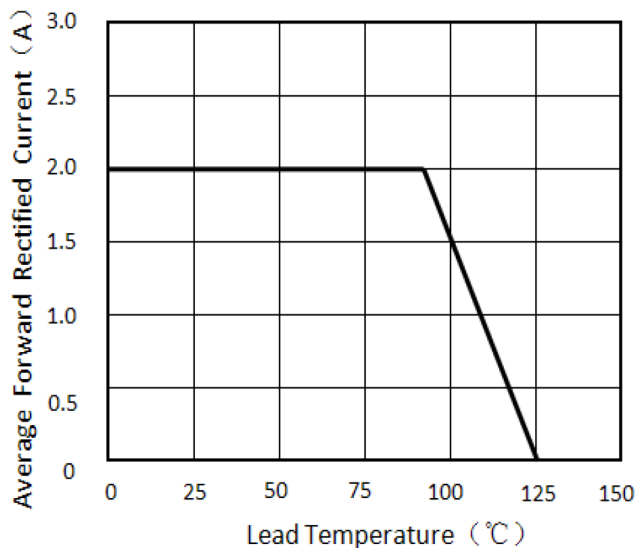


Figure 1. Forward Current Derating Curve

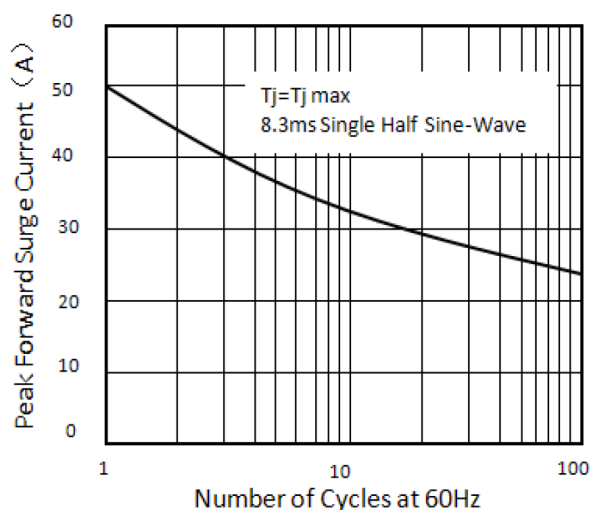


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

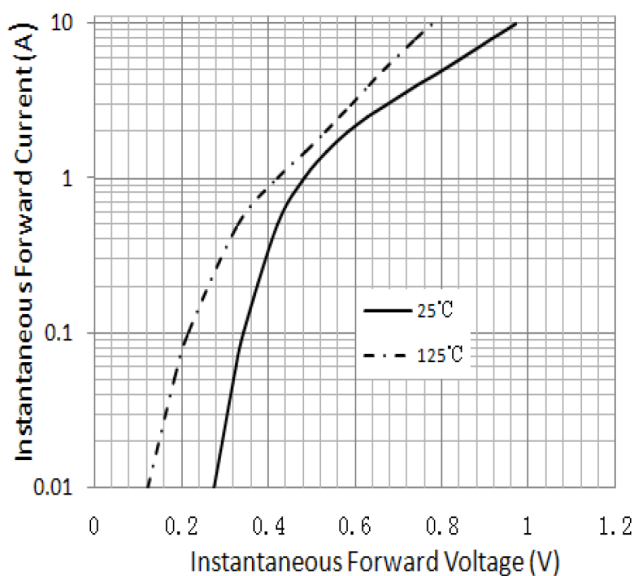


Figure 3. Typical Instantaneous Forward Characteristics

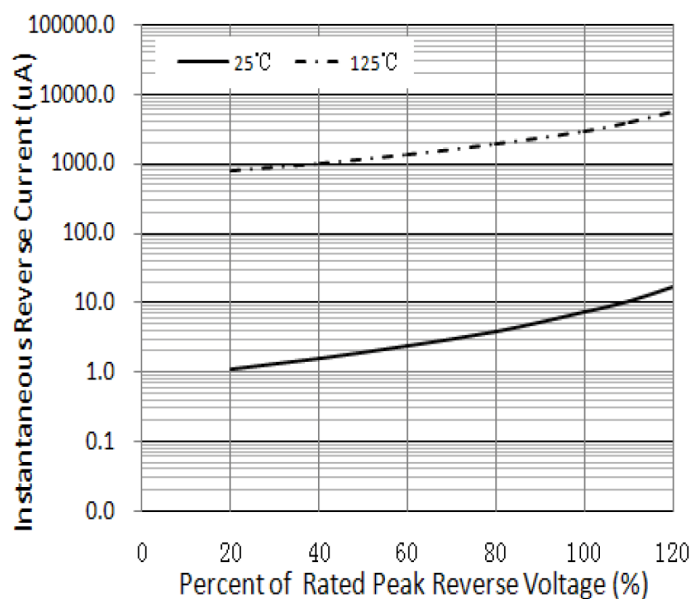
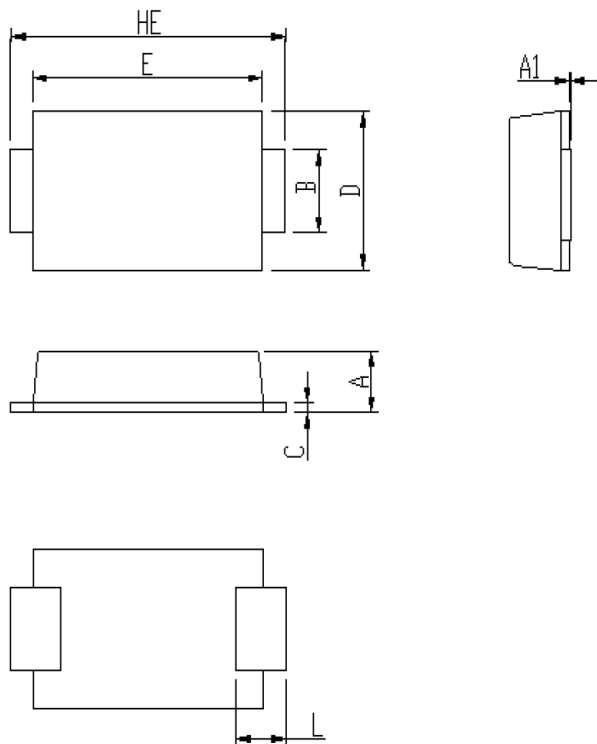


Figure 4. Typical Reverse Characteristics

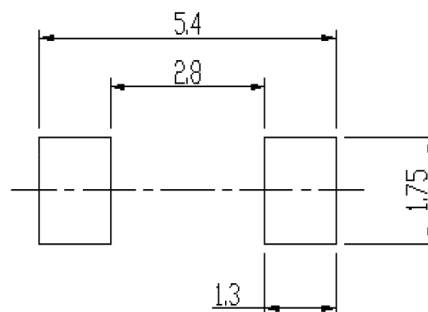
Package Outline Dimensions

eSGB (SMAF)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.92	1.08	0.036	0.043
A1	0	0.1	0.000	0.004
B	1.25	1.45	0.049	0.057
C	0.1	0.25	0.004	0.010
D	2.6	2.8	0.102	0.110
E	4.1	4.3	0.161	0.169
L	0.7	1.1	0.028	0.043
HE	4.8	5.2	0.189	0.205

Soldering footprint



Packing Information

Packing quantities:

10,000 pcs/Reel, 12mm Tape, 13" Reel

Reel Tape & Reel Specification

